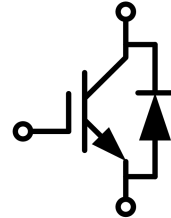


IGBT Discrete with Anti-Parallel Diode

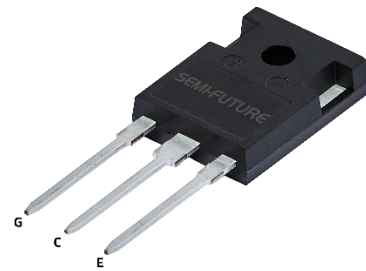
电气特性/ Features and Benefits:

- 1200V 沟槽栅/场终止工艺
1200V Trench with Field Stop Technology
- 低开关损耗
Low switching losses
- Vcesat 正温度系数
Vcesat with positive Temperature Coefficient



典型应用/ Applications:

- 储能逆变器
Energy storage inverter
- 不间断电源
Uninterruptible power supplies
- 光伏逆变器
Solar inverters



$V_{CES} = 1200V$, $I_{C\ nom} = 50A$ / $I_{CRM} = 150A$

关键性能和程序参数 / Key Performance And Package Parameters

Type	V_{CE}	I_C	$V_{CESat}, T_{vj}=25^{\circ}C$	T_{vjmax}	Package
SD50R12A6HS	1200V	50A	2.15V	175°C	TO-247-3L

双极晶体管/IGBT

最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
集电极-发射极电压 Collector-Emitter Voltage	$T_{vj}=25^{\circ}C$	V_{CES}	1200	V
连续集电极直流电流 Continuous DC collector current	$T_C=80^{\circ}C, T_{vj\ max}=175^{\circ}C$	$I_{C\ nom}$	50	A

集电极重复峰值电流 Repetitive peak collector current	$t_p=1\text{ ms}$	I_{CRM}	150	A
栅极-发射极电压 Gate emitter voltage	$t_p \leq 0.5\mu\text{s}, D < 0.001$	V_{GE}	± 20 $+30$	V
短路时间 Short-circuit withstand time	$V_{CC} \leq 600\text{ V}, V_{GE} = 15\text{ V}$, Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0\text{ s}, T_{vj} = 150\text{ }^\circ\text{C}$	t_{SC}	10	μs
总功率损耗 Total power dissipation	$T_C = 25^\circ\text{C}, T_{vj\text{ max}} = 175^\circ\text{C}$ $T_C = 100^\circ\text{C}, T_{vj\text{ max}} = 175^\circ\text{C}$	P_{tot}	900 500	W
在开关状态下温度 Temperature under switching conditions		$T_{vj\text{ op}}$	-40...+175	$^\circ\text{C}$
储存温度 Storage temperature		T_{stg}	-40...+150	$^\circ\text{C}$

热特性 / Thermal Characteristics

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
IGBT 热阻, 结-壳 IGBT thermal resistance, junction - case		$R_{th(j-c)}$		0.138		K/W
二极管热阻, 结-壳 Diode thermal resistance, junction - case		$R_{th(j-c)}$		0.393		K/W

特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
击穿电压 Collector-emitter breakdown voltage	$V_{GE}=0\text{V}, I_c=0.25\text{mA}$	$V_{(BR)CES}$	1200			V
集电极-发射极饱和电压 Collector-Emitter saturation Voltage	$V_{GE}=15\text{V}, I_c=50\text{A}$ $V_{GE}=15\text{V}, I_c=50\text{A}$ $V_{GE}=15\text{V}, I_c=50\text{A}$	V_{CEsat}		2.15 2.80 2.91	2.40	
栅极-发射极阈值电压 Gate-Emitter threshold Voltage	$I_c=0.4\text{mA}, V_{GE}=V_{CE}$ $T_{vj}=25^\circ\text{C}$	$V_{GE(th)}$	4.9	5.5	6.1	
跨导 Transconductance	$V_{CE}=20\text{V}, I_c=50\text{A}$	G_{fs}		30		S

内部栅极电阻 Internal gate resistor	$T_{vj} = 25\text{ }^{\circ}\text{C}$	R_{Gint}		2.3		Ω
输入电容 Input capacitance	$f=1\text{ }00\text{KHZ}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$ $T_{vj}=25\text{ }^{\circ}\text{C}$	C_{ies}		3.12		nF
输出电容 Output capacitance		C_{oes}		0.24		
反向传输电容 Reverse transfer capacitance		C_{res}		0.12		
门极电荷 Gate charge	$I_C = 50\text{A}, V_{GE} = 15\text{V},$ $V_{CE} = 960\text{V}$	$T_{vj}=25\text{ }^{\circ}\text{C}$	Q_G	300		μC
集电极-发射极截止电流 Collector-emitter cut-off current	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}$	$T_{vj}=25\text{ }^{\circ}\text{C}$ $T_{vj}=175\text{ }^{\circ}\text{C}$	I_{CES}	3000	1	μA
栅极-发射极漏电流 Gate-emitter leakage current	$V_{CE}=0\text{V}, V_{GE}=20\text{V}$	$T_{vj}=25\text{ }^{\circ}\text{C}$	I_{GES}		100	nA
开通延迟时间 Turn-on delay time	$I_C=50\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=10\Omega$ (电感负载) / (inductive load)	$T_{vj}=25\text{ }^{\circ}\text{C}$ $T_{vj}=175\text{ }^{\circ}\text{C}$	t_{don}	57 50		ns
上升时间 Rise time	$I_C=50\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=10\Omega$ (电感负载) / (inductive load)	$T_{vj}=25\text{ }^{\circ}\text{C}$ $T_{vj}=175\text{ }^{\circ}\text{C}$	t_r	134 69		
关断延迟时间 Turn-off delay time	$I_C=50\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=10\Omega$ (电感负载) / (inductive load)	$T_{vj}=25\text{ }^{\circ}\text{C}$ $T_{vj}=175\text{ }^{\circ}\text{C}$	t_{doff}	156 237		
下降时间 Fall time	$I_C=50\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=10\Omega$ (电感负载) / (inductive load)	$T_{vj}=25\text{ }^{\circ}\text{C}$ $T_{vj}=175\text{ }^{\circ}\text{C}$	t_f	136 160		
开通损耗能量 (每脉冲) Turn-on energy loss per pulse	$I_C=50\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=10\Omega$ $di/dt = 340\text{ A}/\mu\text{s}$ ($T_{vj} = 175\text{ }^{\circ}\text{C}$)	$T_{vj}=25\text{ }^{\circ}\text{C}$ $T_{vj}=175\text{ }^{\circ}\text{C}$	E_{on}	6.50 10.0		mJ
关断损耗能量 (每脉冲) Turn-off energy loss per pulse	$I_C=50\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}, R_G=10\Omega$ $dv/dt = 5700\text{ V}/\mu\text{s}$ ($T_{vj} = 175\text{ }^{\circ}\text{C}$)	$T_{vj}=25\text{ }^{\circ}\text{C}$ $T_{vj}=175\text{ }^{\circ}\text{C}$	E_{off}	2.20 3.70		mJ

二极管/Diode

最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
反向重复峰值电压 Repetitive peak reverse Voltage	$T_{vj}=25^{\circ}\text{C}$	V_{RRM}	1200	V
连续正向直流电流 Continuous DC forward current	$T_C=100^{\circ}\text{C}$, $T_{vj\max}=175^{\circ}\text{C}$	I_F	30	A
正向重复峰值电流 Repetitive peak forward current	$t_p=1\text{ms}$	I_{FRM}	100	A
I^2t 值 I^2t -value	$t_p=10\text{ms}$, $\sin 180^{\circ}$, $T_j=125^{\circ}\text{C}$	I^2t	310	A

特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
正向电压 Forward Voltage	$I_F=40\text{A}$, $V_{GE}=0\text{V}$ $I_F=40\text{A}$, $V_{GE}=0\text{V}$ $I_F=40\text{A}$, $V_{GE}=0\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=150^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	V_F	1.82 1.60 1.54	2.40	V
反向恢复峰值电流 Peak reverse recovery current	$I_F=50\text{A}$, $-di_F/dt=350\text{A}/\mu\text{s}(T_{vj}=175^{\circ}\text{C})$ $V_R=600\text{V}$, $V_{GE}=-15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	I_{RM}	10.3 30.0		A
反向恢复电荷 Reverse Recovered charge	$I_F=50\text{A}$, $-di_F/dt=350\text{A}/\mu\text{s}(T_{vj}=175^{\circ}\text{C})$ $V_R=600\text{V}$, $V_{GE}=-15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	Q_{rr}	3.69 11.8		μC
反向恢复时间 Reverse Recovery Time	$I_F=50\text{A}$, $-di_F/dt=290\text{A}/\mu\text{s}(T_{vj}=175^{\circ}\text{C})$ $V_R=600\text{V}$, $V_{GE}=-15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	t_{rr}	678 1120		ns
反向恢复损耗（每脉冲） Reverse recovered energy	$I_F=50\text{A}$, $-di_F/dt=290\text{A}/\mu\text{s}(T_{vj}=175^{\circ}\text{C})$ $V_R=600\text{V}$, $V_{GE}=-15\text{V}$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	E_{rec}	1.53 4.78		mJ

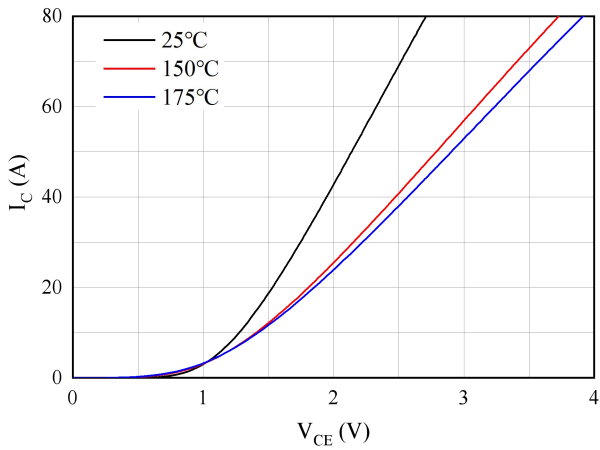


图 1. 典型输出特性 ($V_{GE}=15V$)

Figure 1. Typical output characteristics ($V_{GE}=15V$)

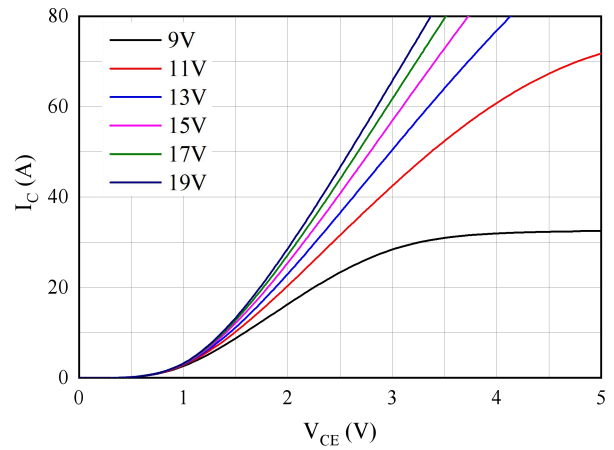


图 2. 典型输出特性 ($T_{vj}=150^{\circ}C$)

Figure 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)

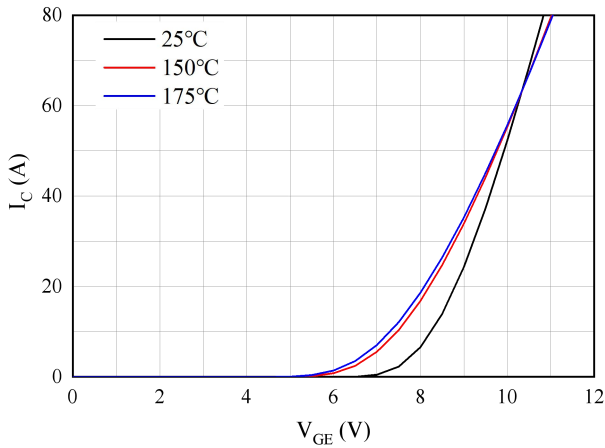


图 3. 典型传输特性($V_{CE}=20V$)

Figure 3. Typical transfer characteristic($V_{CE}=20V$)

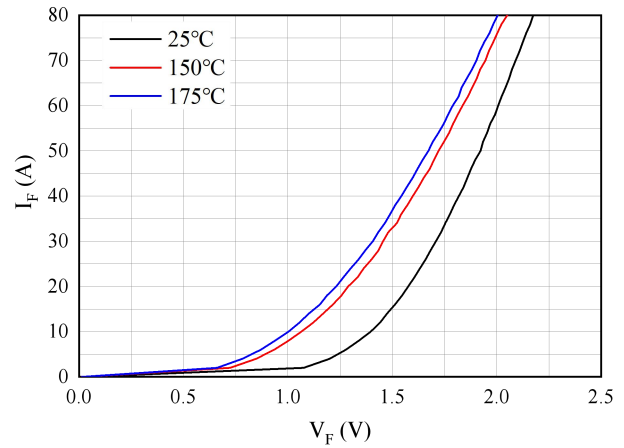


图 4. 正向偏压特性 二极管

Figure 4. Forward characteristic of Diode

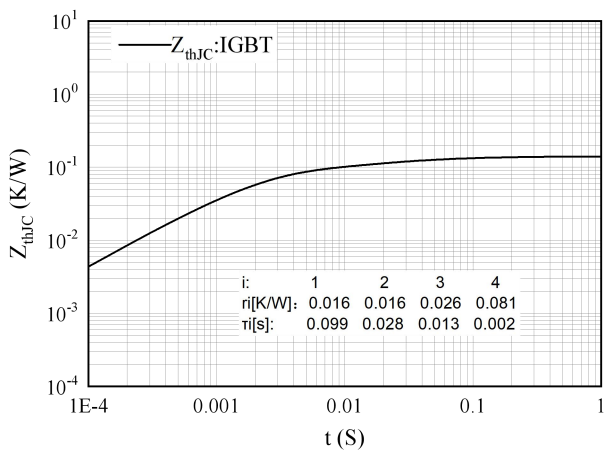


图 5. 瞬态热阻抗 IGBT

Figure 5. Transient thermal impedance IGBT,
 $Z_{thJC}=f(t)$

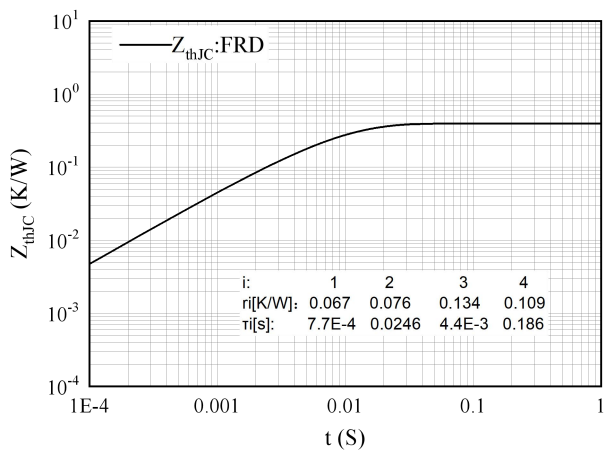


图 6. 瞬态热阻抗 FRD

Figure 6. Transient thermal impedance FRD,
 $Z_{thJC}=f(t)$

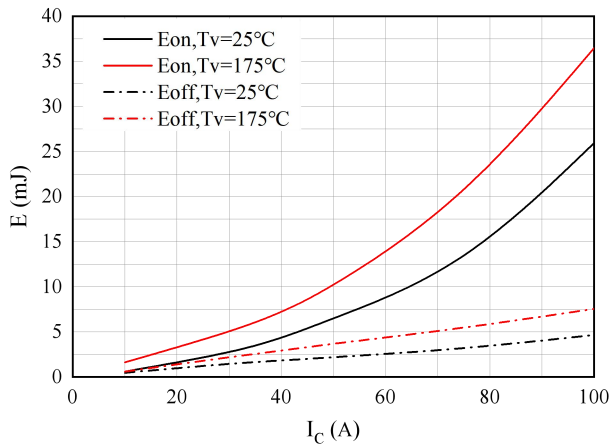


图 7. 开关损耗

Figure 7. Switching losses of IGBT

$V_{GE} = \pm 15, R_G = 10\Omega, V_{CE} = 600V$

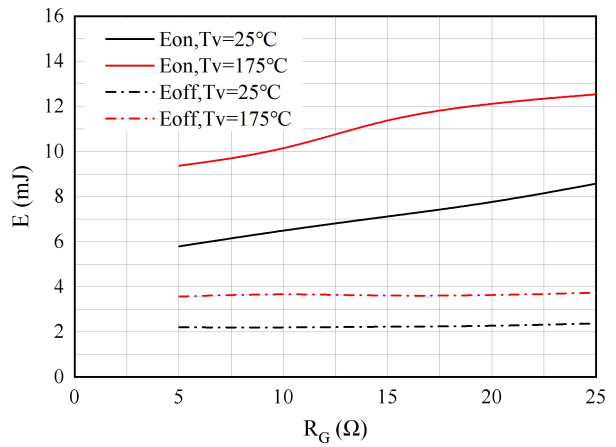


图 8. 开关损耗

Figure 8. Switching losses of IGBT

$V_{GE} = \pm 15V, I_C = 50A, V_{CE} = 600V$

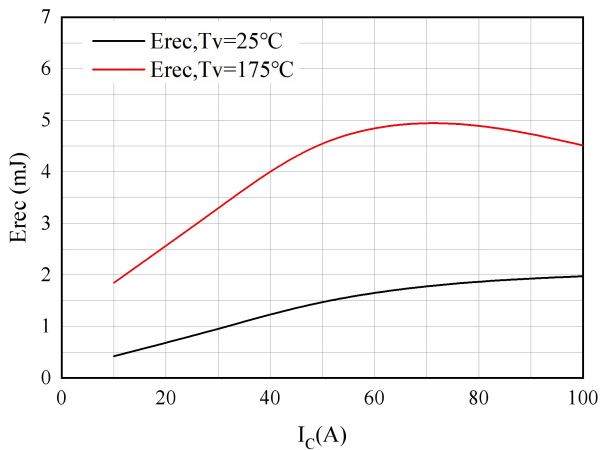


图 9. 开关损耗 二极管

Figure 9. Switching losses of Diode

$R_G = 10\Omega, V_{CE} = 600V$

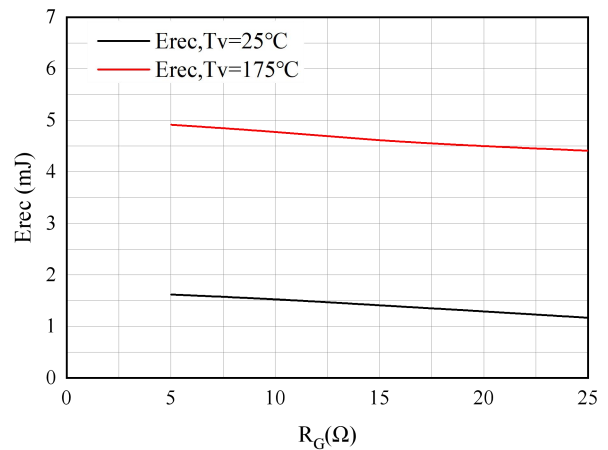


图 10. 开关损耗 二极管

Figure 10. Switching losses of Diode

$I_F = 50A, V_{CE} = 600V$

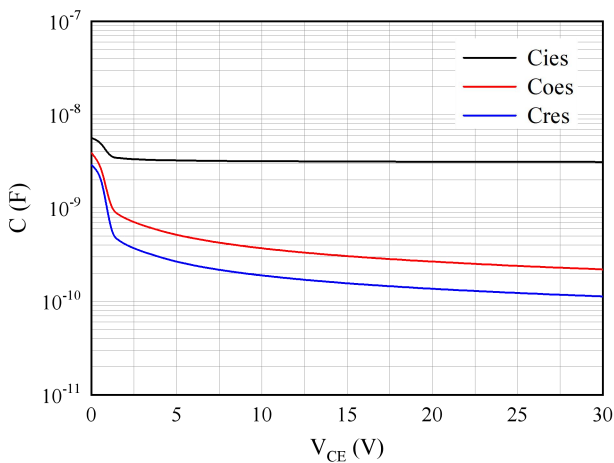
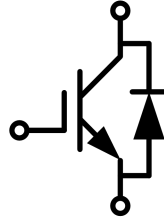


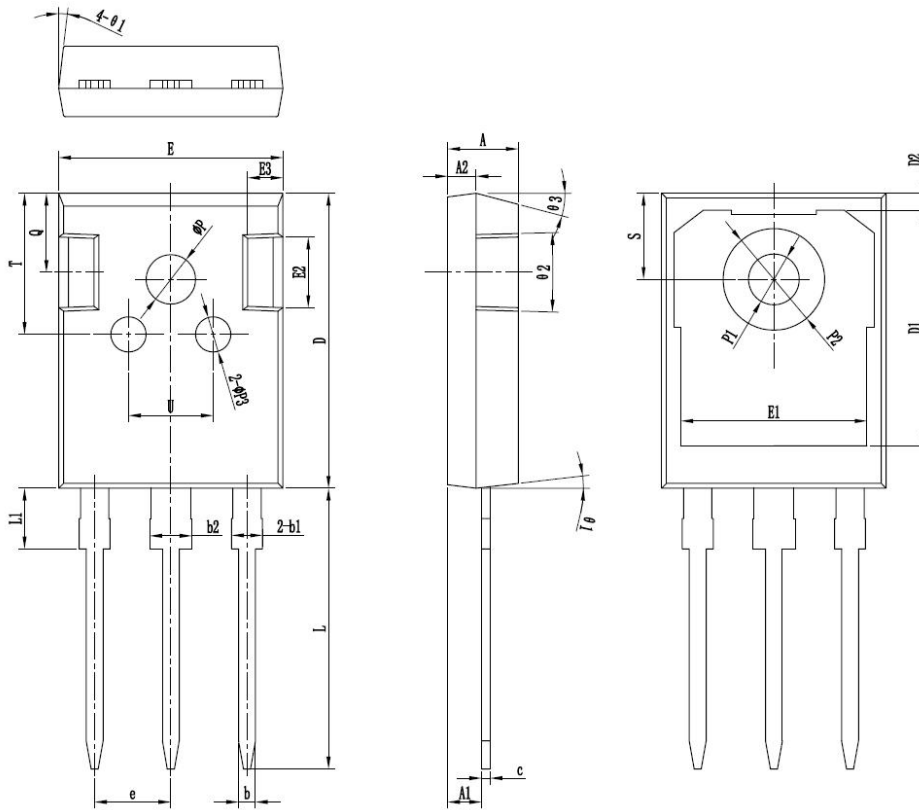
图 11. 电容特性

Figure 11. Capacitance characteristic

接线图 / Circuit diagram



封装尺寸 / Package outlines



符号	单位:mm		
	MIN	NOM	MAX
*A	4.90	5.00	5.10
*A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
*b	1.15	1.20	1.25
*b1	1.95	2.10	2.25
*b2	2.95	3.10	3.25
*c	0.55	0.60	0.65
*D	20.90	21.00	21.10
D1	16.35	16.55	16.75
D2	1.05	1.20	1.35
*E	15.70	15.80	15.90
E1	13.10	13.25	13.40
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
*e	5.40	5.44	5.48
*L	19.80	19.92	20.10
*L1	-	-	4.30
*P	3.70	3.80	3.90
*P1	3.50	3.60	3.70
*P2	7.00	7.20	7.40
*P3	2.40	2.50	2.60
Q	5.60	5.80	6.00
*S	6.05	6.15	6.25
T	9.80	10.00	10.20
U	6.00	6.20	6.40
θ1	5°	7°	9°
θ2	1°	3°	5°
θ3	13°	15°	17°

*为关键管控尺寸